**2**001/010

MAY 1 2 2006

Docket	No.:	2336-256
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PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

METHOD FOR SEPARATING SAPPHIRE WAFER INTO CHIPS USING DRY-ETCHING

In re Application of

Ju Hyun KIM et al.

Confirmation No.: 9586

U.S. Patent Application No. 10/810,634

Group Art Unit: 2823

Filed: March 29, 2004

Examiner: FERNANDO L TOLEDO

Dear Sir:

For:

Transmitted herewith is an Amendment in the above identified application.

No additional fee is required.

Small entity status of this application has been established.

Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	20	20	0	x \$ 50 =	\$ 0.
Independent Claims	4	3 .	1	x \$200 =	\$ 200
		If multiple claims nev Fee for extension of t		d \$360.00	
				TOTAL FEE DUE	\$ 200

A credit card authorization form in the amount of \$200.00 is attached

The Commissioner is hereby authorized to charge payment of any deficiency in fees associated with this communication or credit any overpayment, to Deposit Account No. 07-1337, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully subpattleti

LOWE HAUPTMAN & BERNER, LLP

Benjamin J. Haupunan Registration No.: 29,310

CERTIFICATION OF FACSIMILE TRANSMITTAL I HEREBY CERTIFY THAT THIS PAPER IS BEING FACSIMILE TRANSMITTED TO THE U.S. PATENT AND TRADEMARK OFFICE ON THE DATE SHOWN BELOW

TYPE OR PRINT NAME OF PERSON SIGNING CERTIFICATION

USPTO Customer No. 22429 1700 Diagonal Road, Suite 300 Alexandria, Virginia 22314 (703) 684-1111 BJH/KL/ayw (703) 518-5499 Facsimile Date: May 12, 2006

SIGNATURE

2006 DATE

273-8300

MAY 1 2 2006

Docket No.: 2336-256

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Ju Hyun KIM et al.

Confirmation No. 9586

U.S. Patent Application No. 10/810,634

: Group Art Unit: 2812

Filed: March 29, 2004

: Examiner: Fernando L Toledo

For:

METHOD FOR SEPARATING SAPPHIRE WAFER INTO CHIPS USING DRY-

**ETCHING** 

## **AMENDMENT**

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria VA 22313-1450

Sir:

The following amendments and remarks are submitted in response to the Official Action dated February 13, 2006.

CERTIFICATION OF FACSIMILE TRANSMITTAL

I HEREBY CERTIFY THAT THIS PAPER IS BEING FACSIMILE TRANSMITTED TO THE
U.S. PATENT AND TRADEMARK OFFICE ON THE DATE SHOWN BELOW

	Ayesha Wilson				
TYPE OR PRINT NAME OF PERSON SI	GNING CERTIFICATION				
Lusta Will	May 12, 2006				
SIGNATURE	DATE				
(571) 273-8300	)				

05/15/2006 MBINAS

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